DATA SHEET



MOS FIELD EFFECT TRANSISTOR

2SK3355

SWITCHING N-CHANNEL POWER MOS FET

DESCRIPTION

The 2SK3355 is N-channel MOS Field Effect Transistor designed for high current switching applications.

FEATURES

- Super low on-state resistance:
- $R_{\text{DS(on)1}}$ = 5.8 m Ω MAX. (Vgs = 10 V, ID = 42 A)
- $R_{DS(on)2} = 8.8 \text{ m}\Omega \text{ MAX.} (V_{GS} = 4.0 \text{ V}, \text{ ID} = 42 \text{ A})$
- Low Ciss: $C_{iss} = 9800 \text{ pF TYP}.$
- Built-in gate protection diode

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

	•		
Drain to Source Voltage (VGs = 0 V)	VDSS	60	V
Gate to Source Voltage (VDS = 0 V)	VGSS(AC)	±20	V
Drain Current (DC) (Tc = 25°C)	D(DC)	±83	А
Drain Current (pulse) Note1	D(pulse)	±332	А
Total Power Dissipation (Tc = 25°C)	Ρτ	100	W
Total Power Dissipation ($T_A = 25^{\circ}C$)	Ρτ	1.5	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current Note2	las	75	А
Single Avalanche Energy Note2	Eas	562	mJ

Notes 1. PW \leq 10 $\mu s,$ Duty cycle \leq 1 %

2. Starting T_{ch} = 25°C, V_{DD} = 30 V, R_G = 25 Ω , V_{GS} = 20 \rightarrow 0 V

ORDERING INFORMATION

PART NUMBER	PACKAGE	
2SK3355	TO-220AB	
2SK3355-S	TO-262	
2SK3355-ZJ	TO-263	
2SK3355-Z	TO-220SMD ^{Note}	

Note TO-220SMD package is produced only in Japan.

(TO-220AB)



(TO-262)



(TO-263, TO-220SMD)



The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version. Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

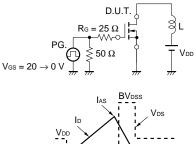
ELECTRICAL CHARACTERISTICS (TA = 25 °C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	Vds = 60 V, Vgs = 0 V			10	μA
Gate Leakage Current	lgss	$V_{GS} = \pm 20 V$, $V_{DS} = 0 V$			±10	μA
Gate Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	1.5	2.0	2.5	V
Forward Transfer Admittance	y _{fs}	V _{DS} = 10 V, I _D = 42 A	39	77		S
Drain to Source On-state Resistance	RDS(on)1	$V_{GS} = 10 V, I_D = 42 A$		4.6	5.8	mΩ
	RDS(on)2	$V_{GS} = 4.0 V$, $I_D = 42 A$		6.1	8.8	mΩ
Input Capacitance	Ciss	V _{DS} = 10 V		9800		pF
Output Capacitance	Coss	Vgs = 0 V		1500		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		630		pF
Turn-on Delay Time	td(on)	$V_{DD} = 30 V, I_D = 42 A$		130		ns
Rise Time	tr	Vgs = 10 V		1450		ns
Turn-off Delay Time	td(off)	Rg = 10 Ω		510		ns
Fall Time	tr			510		ns
Total Gate Charge	Q _G	V _{DD} = 48 V		170		nC
Gate to Source Charge	Q _{GS}	Vgs = 10 V		28		nC
Gate to Drain Charge	Qgd	ID = 83 A		46		nC
Body Diode Forward Voltage	VF(S-D)	IF = 83 A, VGS = 0 V		0.99		V
Reverse Recovery Time	trr	IF = 83 A, VGS = 0 V		64		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/µs		130		nC

TEST CIRCUIT 1 AVALANCHE CAPABILITY

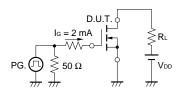
TEST CIRCUIT 2 SWITCHING TIME

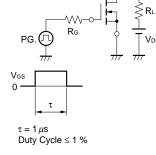
D.U.T

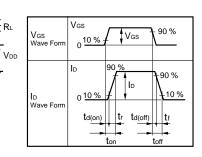


Starting Tch

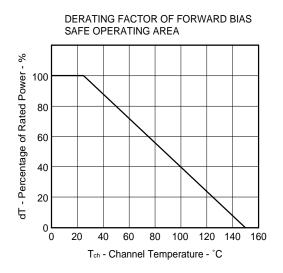
TEST CIRCUIT 3 GATE CHARGE



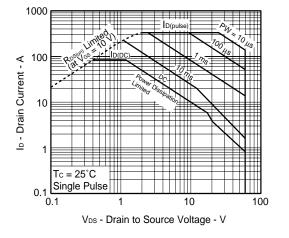




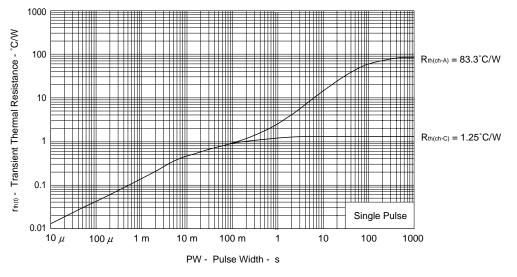
TYPICAL CHARACTERISTICS (TA = 25 °C)



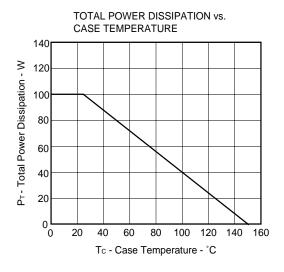




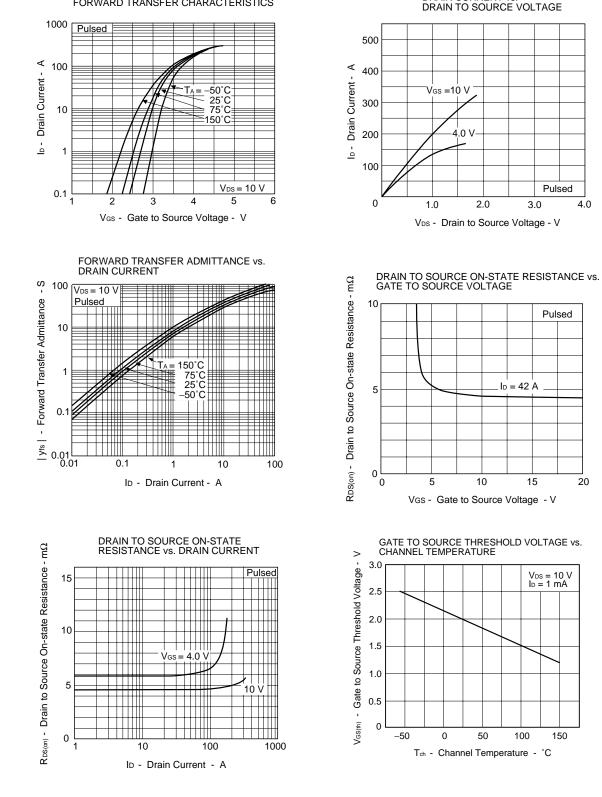
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



Data Sheet D14132EJ5V0DS

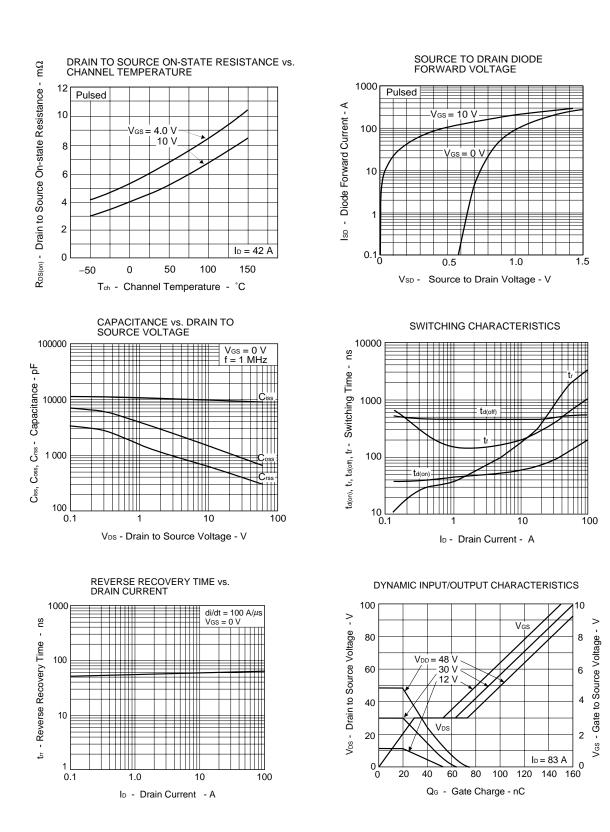


DRAIN CURRENT vs.

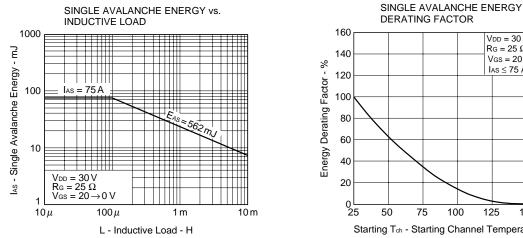


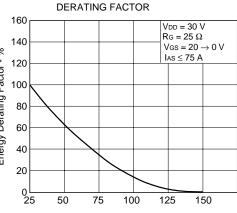
FORWARD TRANSFER CHARACTERISTICS

NEC



5

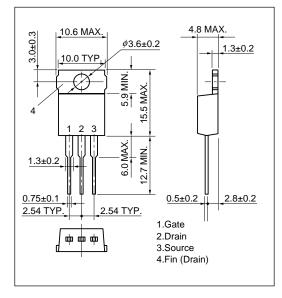




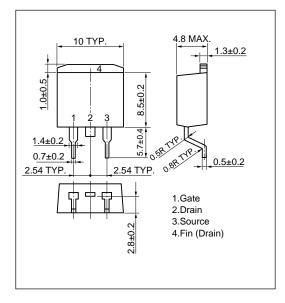
Starting T_ch - Starting Channel Temperature - $^\circ\text{C}$

★ PACKAGE DRAWINGS (Unit: mm)

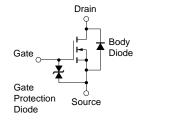
1) TO-220AB(MP-25)



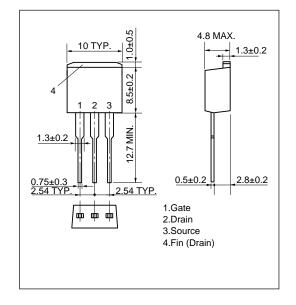
3) TO-263 (MP-25ZJ)



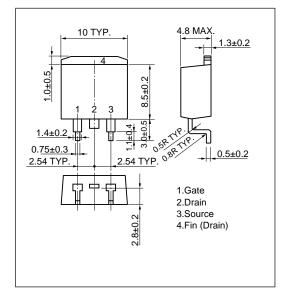
EQUIVALENT CIRCUIT



2) TO-262(MP-25 Fin Cut)



4) TO-220SMD(MP-25Z)^{Note}



Note This package is produced only in Japan.

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

Data Sheet D14132EJ5V0DS

- The information in this document is current as of July, 2002. The information is subject to change without notice. For actual design-in, refer to the latest publications of NEC's data sheets or data books, etc., for the most up-to-date specifications of NEC semiconductor products. Not all products and/or types are available in every country. Please check with an NEC sales representative for availability and additional information.
- No part of this document may be copied or reproduced in any form or by any means without prior written consent of NEC. NEC assumes no responsibility for any errors that may appear in this document.
- NEC does not assume any liability for infringement of patents, copyrights or other intellectual property rights of third parties by or arising from the use of NEC semiconductor products listed in this document or any other liability arising from the use of such products. No license, express, implied or otherwise, is granted under any patents, copyrights or other intellectual property rights of NEC or others.
- Descriptions of circuits, software and other related information in this document are provided for illustrative
 purposes in semiconductor product operation and application examples. The incorporation of these
 circuits, software and information in the design of customer's equipment shall be done under the full
 responsibility of customer. NEC assumes no responsibility for any losses incurred by customers or third
 parties arising from the use of these circuits, software and information.
- While NEC endeavours to enhance the quality, reliability and safety of NEC semiconductor products, customers
 agree and acknowledge that the possibility of defects thereof cannot be eliminated entirely. To minimize
 risks of damage to property or injury (including death) to persons arising from defects in NEC
 semiconductor products, customers must incorporate sufficient safety measures in their design, such as
 redundancy, fire-containment, and anti-failure features.
- NEC semiconductor products are classified into the following three quality grades:
 "Standard", "Special" and "Specific". The "Specific" quality grade applies only to semiconductor products
 developed based on a customer-designated "quality assurance program" for a specific application. The
 recommended applications of a semiconductor product depend on its quality grade, as indicated below.
 Customers must check the quality grade of each semiconductor product before using it in a particular
 application.
 - "Standard": Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots
 - "Special": Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)
 - "Specific": Aircraft, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems and medical equipment for life support, etc.

The quality grade of NEC semiconductor products is "Standard" unless otherwise expressly specified in NEC's data sheets or data books, etc. If customers wish to use NEC semiconductor products in applications not intended by NEC, they must contact an NEC sales representative in advance to determine NEC's willingness to support a given application.

(Note)

(1) "NEC" as used in this statement means NEC Corporation and also includes its majority-owned subsidiaries.

(2) "NEC semiconductor products" means any semiconductor product developed or manufactured by or for NEC (as defined above).

M8E 00.4